

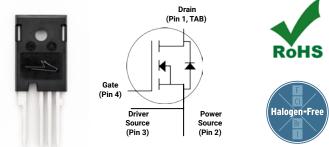
# C3M0060065K

## Silicon Carbide Power MOSFET C3M<sup>™</sup> MOSFET Technology

N-Channel Enhancement Mode

### Features

- 3<sup>rd</sup> Generation SiC MOSFET technology
- High blocking voltage with low on-resistance
- High speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q<sub>rr</sub>)
- Halogen free, RoHS compliant



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Ordering Part Number	Package	Marking		
C3M0060065K	TO-247-4	C3M0060065K		

### **Typical Applications**

- EV charging
- Server power supplies
- Solar PV inverters
- UPS
- DC/DC converters

### **Benefits**

- Higher system efficiency
- Reduced cooling requirements
- Increased power density
- Increased system switching frequency
- Easy to parallel and simple to drive
- Enable new hard switching PFC topologies (Totem-Pole)

### **Key Parameters**

Parameter	Symbol	Min.	Тур.	Мах	Unit	Conditions	Note
Drain - Source Voltage	V <sub>DS</sub>			650		T <sub>c</sub> = 25°C	
Maximum Gate - Source Voltage	V <sub>GS(max)</sub>	-8		+19	v	Transient	
Operational Gate-Source Voltage	V <sub>GS op</sub>		-4/15			Static	Note 1
DC Continuous Drain Current				37	A	V <sub>GS</sub> = 15 V, T <sub>c</sub> = 25 °C, T <sub>J</sub> ≤175 °C	Fig. 19 Note 2
	I <sub>D</sub>			27		$V_{GS} = 15 \text{ V}, \text{ T}_{C} = 100 \text{ °C}, \text{ T}_{J} \le 175 \text{ °C}$	
Pulsed Drain Current	I <sub>DM</sub>			99		$t_{Pmax}$ limited by $T_{jmax}$ $V_{GS} = 15V, T_{C} = 25 \text{ °C}$	Fig. 22
Power Dissipation	P <sub>D</sub>			150	w	$T_{c} = 25^{\circ}C, T_{J} = 175^{\circ}C$	Fig. 20
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>			-40 to +175	°C		
Solder Temperature	TL			260		According to JEDEC J-STD-020	
Mounting Torque	M <sub>D</sub>			1 8.8	Nm Ibf-in	M3 or 6-32 screw	

Note (1): Recommended turn-on gate voltage is 15V with ±5% regulation tolerance, see Application Note PRD-04814 for additional details Note (2): Verified by design

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### **Electrical Characteristics** ( $T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note	
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	650	-	-		$V_{GS} = 0$ V, $I_D = 100$ $\mu$ A		
		1.8	2.3	3.6	V	$V_{\rm DS} = V_{\rm GS,} I_{\rm D} = 5 \text{ mA}$	- Fig. 11	
Gate Threshold Voltage	V <sub>GS(th)</sub>	_	1.9	_		$V_{DS} = V_{GS}, I_D = 5 \text{ mA}, T_J = 175^{\circ}C$		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	1	50	μA	$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$		
Gate-Source Leakage Current	I <sub>GSS</sub>	_	10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$		
Drain-Source On-State Resistance	P	42	60	79	mΩ	$V_{GS} = 15 \text{ V}, I_D = 13.2 \text{ A}$	Fig.	
	R <sub>DS(on)</sub>	-	80	_		$V_{GS} = 15 \text{ V}, I_D = 13.2 \text{ A}, T_J = 175^{\circ}\text{C}$	4, 5, 6	
Transconductance	σ.		10		s	$V_{DS} = 20 \text{ V}, \text{ I}_{DS} = 13.2 \text{ A}$		
hansconductance	g <sub>fs</sub>		9		3	$V_{DS} = 20 \text{ V}, \text{ I}_{DS} = 13.2 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	Fig. 7	
Input Capacitance	Ciss		1020	_		$V_{GS} = 0 V, V_{DS} = 600 V$	Fig. 17, 18	
Output Capacitance	C <sub>oss</sub>	_	80	_		<i>f</i> = 1 Mhz		
Reverse Transfer Capacitance	C <sub>rss</sub>	-	9	-	pF	V <sub>AC</sub> = 25 mV		
Effective Output Capacitance (Energy Related)	C <sub>o(er)</sub>	-	95	-			Note 3	
Effective Output Capacitance (Time Related)	C <sub>o(tr)</sub>	-	132	-		$V_{GS} = 0 V, V_{DS} = 0 V to 400 V$		
C <sub>oss</sub> Stored Energy	E <sub>oss</sub>	-	15	-		$V_{DS} = 600 V, f = 1 Mhz$	Fig. 16	
Turn-On Switching Energy (Body Diode)	Eon	-	70	-		$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 13.2 \text{ A},$	- Fig. 25	
Turn Off Switching Energy (Body Diode)	E <sub>off</sub>	-	5	-	μJ	$R_{G(ext)} = 2.5 \Omega$ , L= 135 $\mu$ H, T <sub>J</sub> = 175°C FWD = Internal Body Diode of MOSFET		
Turn-On Switching Energy (External Sic Diode)	Eon	-	67	-		$V_{DS} = 400 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}, I_{D} = 13.2 \text{ A},$		
Turn Off Switching Energy (External Sic Diode)	E <sub>off</sub>	_	6	_		$R_{G(ext)} = 2.5 \Omega$ , L= 135 $\mu$ H, T <sub>J</sub> = 175°C FWD = External SiC DIODE		
Turn-On Delay Time	t <sub>d(on)</sub>	_	8	_		V <sub>DD</sub> = 400 V, V <sub>GS</sub> = -4 V/15 V		
Rise Time	tr	_	11	_		$I_{D} = 13.2 \text{ A}, R_{G(ext)} = 2.5 \Omega,$		
Turn-Off Delay Time	t <sub>d(off)</sub>	_	17	_	ns	L= 135 µH Timing relative to V₅s	Fig. 26	
Fall Time	t <sub>f</sub>	_	5	_		Inductive load		
Internal Gate Resistance	R <sub>G(int)</sub>	_	3	_	Ω	<i>f</i> = 1 MHz, V <sub>AC</sub> = 25 mV		
Gate to Source Charge	Q <sub>gs</sub>	_	13	_				
Gate to Drain Charge	Q <sub>gd</sub>	_	17	_	$\begin{array}{c} \hline \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\$		Fig. 12	
Total Gate Charge	Qg	_	46	_				

Note:

 $^3$  C<sub>o(er)</sub>, a lumped capacitance that gives same stored energy as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 to 400V C<sub>o(tr)</sub>, a lumped capacitance that gives same charging time as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 to 400V

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### **Reverse Diode Characteristics** ( $T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Notes	
Diode Forward Voltage, T <sub>J</sub> = 25°C	N N	5.1	-	N N	$V_{GS} = -4 V$ , $I_{SD} = 6.6 A$ , $T_{J} = 25C$	Fig.	
Diode Forward Voltage, T <sub>J</sub> = 175°C	V <sub>SD</sub>	4.8	_	V	$V_{GS} = -4 V, I_{SD} = 6.6 A, T_{J} = 175C$	8,9,10	
Continuous Diode Forward Current	Is	_	23		V <sub>GS</sub> = -4 V, T <sub>J</sub> = 25°C		
Diode pulse Current	I <sub>SM</sub>	_	99	A $V_{GS} = -4 V$ , pulse width t <sub>P</sub> limite by $T_{jmax}$			
Reverse Recovery Time	t <sub>rr</sub>	11	-	ns			
Reverse Recovery Charge	Q <sub>rr</sub>	151	_	nC	$V_{GS} = -4 V, I_{SD} = 13.2 A, V_{R} = 400 V$ $di_{z}/dt = 4500 A/\mu s, T_{J} = 175^{\circ}C$		
Peak Reverse Recovery Current	I <sub>RRM</sub>	27	_	A			
Reverse Recovery Time	t <sub>rr</sub>	16	_	ns			
Reverse Recovery Charge	Q <sub>rr</sub>	110	_	nC	$V_{GS} = -4 V, I_{SD} = 13.2 A, V_{R} = 400 V$ $di_{z}/dt = 2400 A/\mu s, T_{J} = 175^{\circ}C$		
Peak Reverse Recovery Current	I <sub>RRM</sub>	12	_	А			

### **Thermal Characteristics**

Parameter	Symbol	Тур.	Unit	Note
Thermal Resistance from Junction to Case	R <sub>θJC</sub>	0.99	86.044	Fi- 21
Thermal Resistance From Junction to Ambient	R <sub>0JA</sub>	40	°C/W	Fig. 21



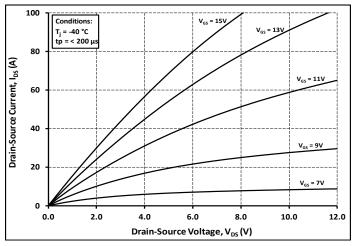
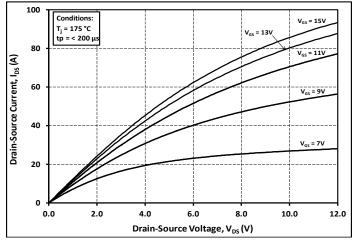
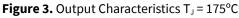
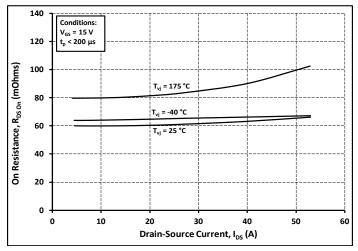
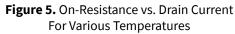


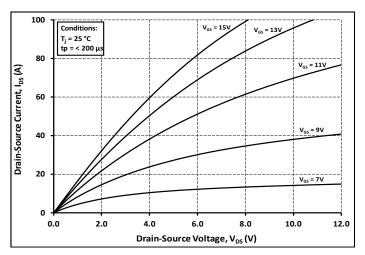
Figure 1. Output Characteristics T<sub>J</sub> = -40°C

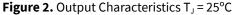












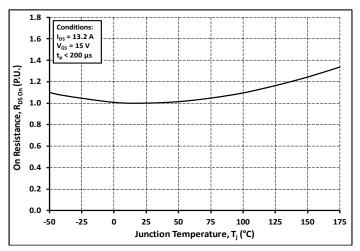
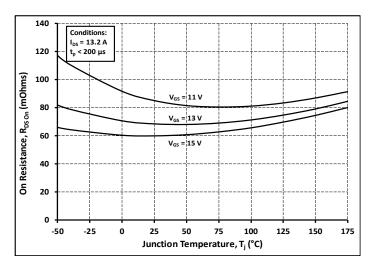
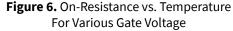


Figure 4. Normalized On-Resistance vs. Temperature

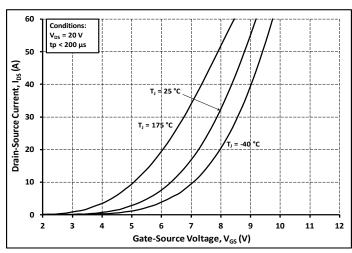


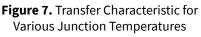


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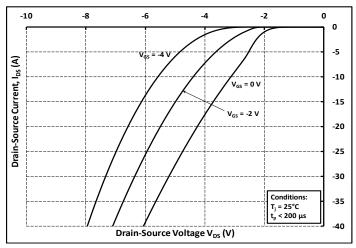


Figure 9. Body Diode Characteristic at 25°C

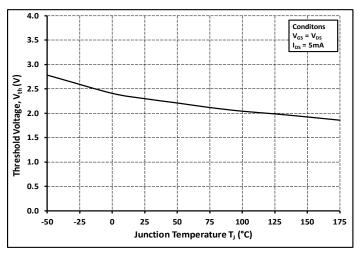


Figure 11. Threshold Voltage vs. Temperature

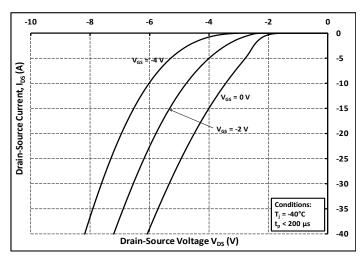


Figure 8. Body Diode Characteristic at -40°C

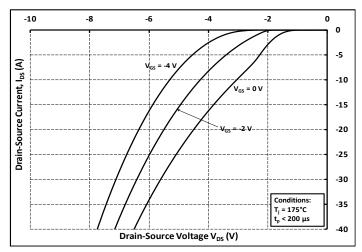


Figure 10. Body Diode Characteristic at 175°C

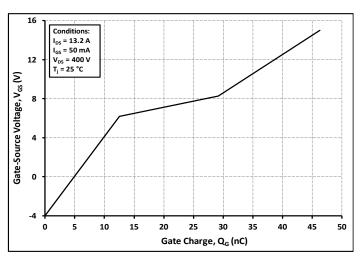


Figure 12. Gate Charge Characteristics

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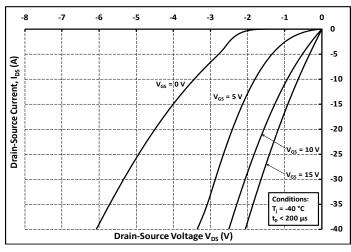


Figure 13. 3rd Quadrant Characteristic at -40°C

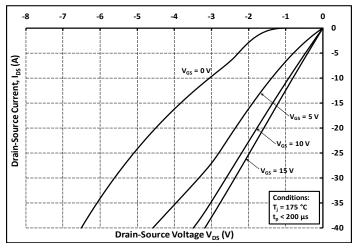
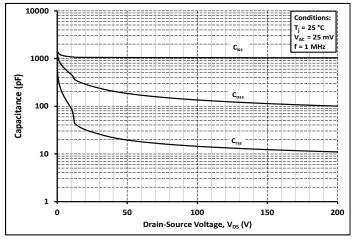
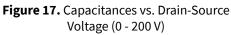


Figure 15. 3rd Quadrant Characteristic at 175°C





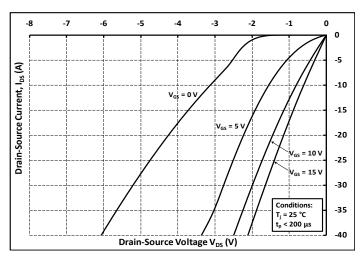


Figure 14. 3rd Quadrant Characteristic at 25°C

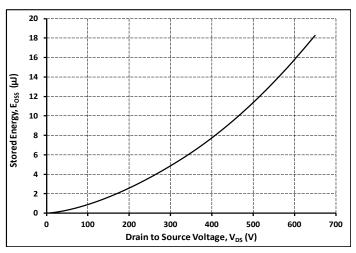


Figure 16. Output Capacitor Stored Energy

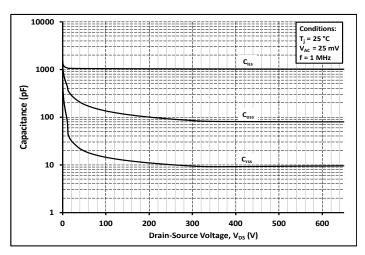
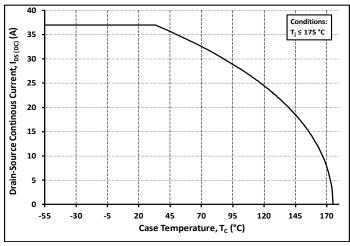


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 650 V)

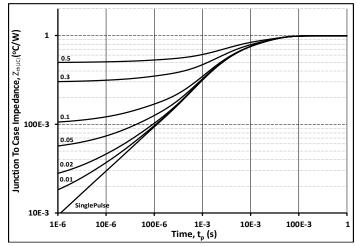
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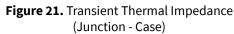
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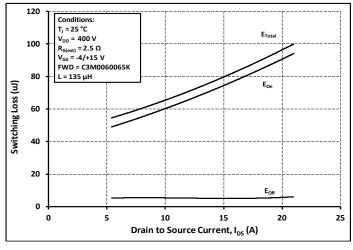


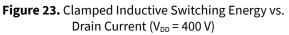












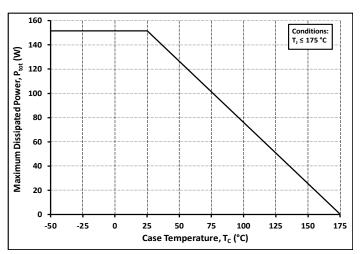


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

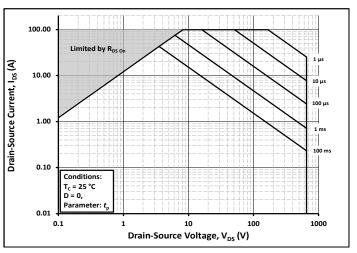
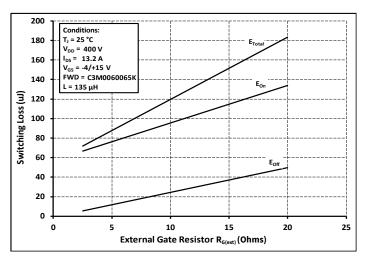
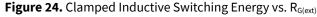


Figure 22. Safe Operating Area





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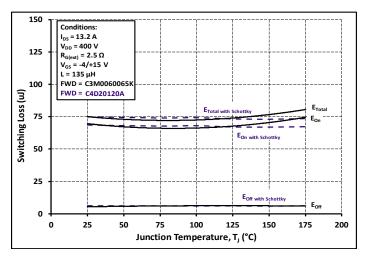
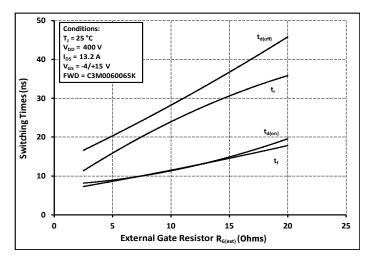


Figure 25. Clamped Inductive Switching Energy vs. Temperature





### **Test Circuit Schematic**

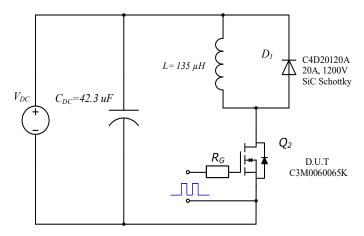


Figure 27. Clamped Inductive Switching Waveform Test Circuit

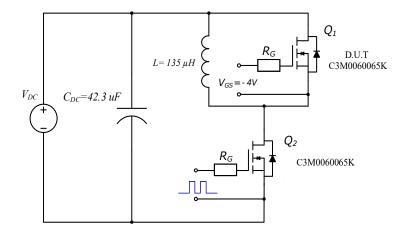


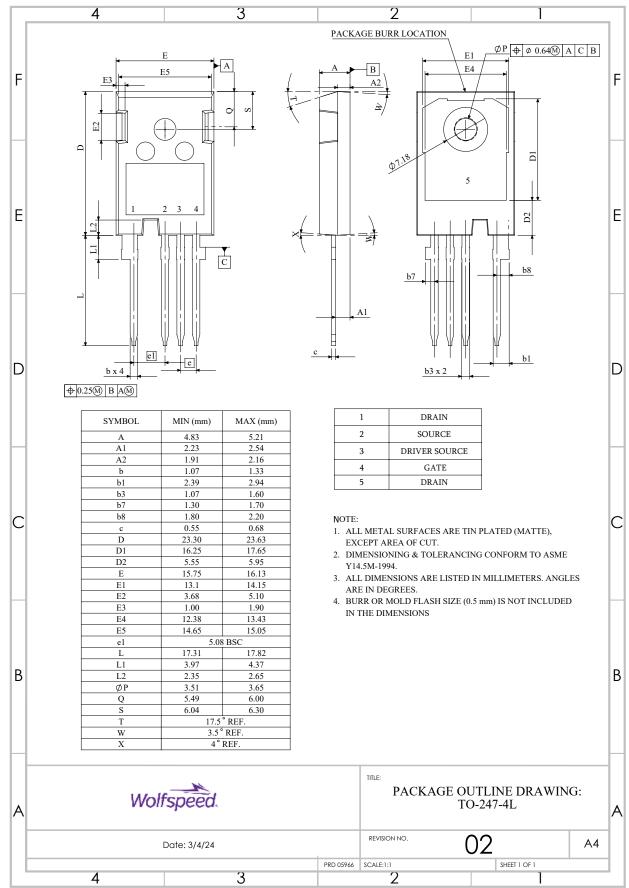
Figure 28. Body Diode Recovery Test Circuit

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### Package Dimensions – Package TO-247-4L

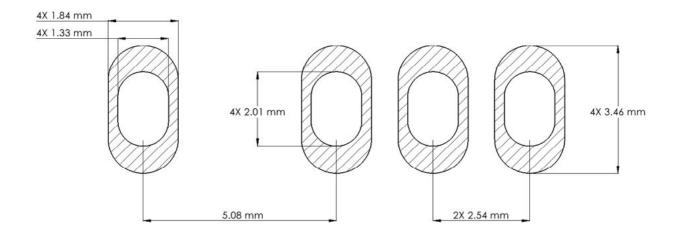


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### **Recommended Solder Pad Layout**



### **Revision history**

Document Version	Date of release	Description of changes
2	July-2020	N/A
3	December-2023	Update Package Drawing, package image, solder pad layout, added revision history table, Table 1 layout revised
5	October - 2024	Legal Disclaimer, POD, Diode Pulse Current Symbol

### **Related Links**

- SPICE Models
- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

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